



JAE Electronics, Inc.  
May 30<sup>th</sup>, 2023

## ENG-E23-056 - Distributors

### PCN (Process Change Notice) MX34016SFA Replacement mold die (D,E) To Keep Production Capacity

Part Number	2 Existing Mold Dies (1 cavity per die)	1 Replacement Mold Die with 2 cavities created	Replacement Mold Die Completion	Proposed PPAP Submission	Start of Mass Production (SOP)
MX34016SFA	(B) & (C)	(D,E) To replace (B)	November 2023	March 2024	June 2024

#### Notes:

- PC = Process Change (Tooling: Transfer, Replacement, Refurbishment, or additional and Parts Produced at Additional Location, etc...)
- PPAP = Production Part Approval Process
  1. PC PPAP will only be prepared and provided to customer who already requested and received initial PPAP.
  2. If you request PC PPAP documents for this notification, please notify us ASAP.